

ID No. 865	Product/Process Change Notification	Date 07.02.2022
Product	Ordering Code	
ELS61-E Rel.2	L30960N4450A200	
Ordering Code changes:	<input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
Product	New Ordering Code	

Reason of Change:

- | | |
|--|--|
| <input checked="" type="checkbox"/> Technical requirement
<input type="checkbox"/> Customer requirement
<input type="checkbox"/> Quality improvement | <input type="checkbox"/> Change of production process/logistical changes
<input type="checkbox"/> Location of production moved
<input type="checkbox"/> Other: |
|--|--|

Description of change:	<p>PCN is to inform about introduction of 2nd source memory for our Cinterion® ELS61-E Rel.2 module.</p> <p>DRAM memory product vendor announced PCN from beginning of 2022. DRAM vendor will provide new MID (Manufacturer ID) consequently.</p> <p>According to the product's datasheet, this 2nd memory source will not change the original memory functions and performances at all, and the customer's module design will not be affected. Thales technical team qualified the new memory source successfully.</p> <p>To be compatible with this 2nd memory source, the software of Thales' modules will have a minor adaption to identify the new memory MID. Thales will introduce the new FW to the above product listed.</p> <p>The existing Approvals are not affected.</p> <p>The new software application string is:</p> <p style="text-align: center;">SVN 03 Rev 02.000 ARN 01.000.07</p> <p>If there are further questions, our FAE team who offers comprehensive customer support, should be contacted.</p>
Schedule details:	CW/YEAR
Availability of SW for evaluation:	CW06/2022
Availability of modules ex THALES DIS AIS Deutschland warehouse:	CW12/2022

Timing note:

If THALES DIS AIS Deutschland GmbH does not receive a notification to the contrary within a period of 6 weeks, THALES DIS AIS Deutschland GmbH assumes that the customer agrees to the change.

Quality assurance measurements:

The new version fulfils all internal test requirements according to our Quality Management process and philosophy.

Attachments:

2/7/2022

07.02.2022

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Product Program Manager
Signed by: SUN Xiao-Lin

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Vice President Quality Management
Signed by: ERDMANN Joerg